

Contents

Volume 86 2008

- 6 **UK Corrosion 2007 and 42nd Corrosion Science Symposium: joint venture between IMF and ICorr**
By J. P. G. Farr
- 19 **Alternative metal electrodeposition onto (photo) electrochemically prepared nanostructured silicon surfaces: solar applications (Hothersall Memorial Award Lecture 2007)**
By H.-J. Lewerenz
- 34 **Conducting polymer coatings in electrochemical technology. Part 2 – Application areas**
By C. Ponce de Léon, S. A. Campbell, J. R. Smith and F. C. Walsh
- 41 **ATR FTIR study of levellers for Cu electrodeposition from acidic sulphate solutions**
By B. Bozzini, L. D'Urzo, S.-J. Huo and W.-B. Cai
- 51 **Pilling-Bedworth ratio of thick anodic aluminium porous films prepared at high voltages in H₂SO₄ based electrolyte**
By L. Arurault
- 55 **Application of bilayer silanisation treatment to improve corrosion resistance and bond durability of aluminium alloy**
By Z. C. Guo, R. M. Wang and Y. F. Wang
- 62 **Materials properties of nanostructured titanium nitride thin films synthesised by DC reactive magnetron sputtering**
By B. Subramanian and M. Jayachandran
- 66 **Magneto-electropolishing for metal surface modification**
By G. N. K. Ramesh Babu, C. Eagammai and S. Jayakrishnan
- 76 **Cross-linking organic coatings with blocked isocyanates**
By R. Jones
- 80 **Innovation moves forward: towards 2025 or we die**
By R. S. Briggs
- 82 **Pulse Plating**
By J. P. G. Farr
- 83 **Pulse plating in the third millennium**
By J. P. G. Farr
- 87 **Mass transfer considerations during pulse plating**
By S. Roy
- 92 **Pulse plating of Ni–W alloys from model electrolytes**
By S. Franz, A. Marlot, P. L. Cavallotti and D. Landolt
- 98 **Influence of high frequency pulse current on properties of electroformed nanocrystalline Ni–Mn alloys**
By J. M. Yang, D. Zhu and D. H. Kim
- 103 **Pulse plating effect on composition and corrosion properties of zinc alloy coatings**
By R. Ramanauskas, L. Gudavičiūtė, O. Ščit, D. Bučinskienė and R. Juškėnas
- 109 **Effect of plating mode and complexing agent on morphology of pigmented anodic alumina coatings**
By M. Zemanová, M. Chovancová, P. Blaho, E. Ušák and J. Valtýni
- 115 **Influence of pulse plating parameters on morphology and hardness of pure tin deposit**
By W. E. G. Hansal, M. Halmdienst, S. Hansal, I. Boussaboua and A. Darchen
- 122 **Bright zinc–nickel alloy deposition from alkaline non-cyanide bath**
By S. Shanmugasigamani and M. Pushpavanam
- 134 **Butler and electrocrystallisation**
By D. R. Gabe
- 136 **AGM Christmas Lecture**
Metal finishing: enhanced performance achieved through plasma processing
By D. Dowling
- 141 **Deposition of cobalt rich Zn–Co alloy coatings of high corrosion resistance**
By S. Lichušina, A. Sudavičius, R. Juškėnas, D. Bučinskienė and E. Juzeliūnas
- 148 **Electrochemistry of tin deposition from mixed sulphate and methanesulphonate electrolyte**
By C. T. J. Low, C. Kerr, B. Des Barker, J. R. Smith, S. A. Campbell and F. C. Walsh
- 153 **Silvery matt coatings of Zn–Mn alloy**
By A. Sulcius and E. Griskonis
- 157 **Electrodeposition and characterisation of Zn, Zn–Fe and Zn–Fe–Ni coatings in presence of gelatin as additive**
By I. H. Karahan, H. A. Çetinkara and H. S. Güder
- 162 **Effect of thermal treatment on yttria doped zirconia coated DIN 1-4306**
By J. Akhtar, S. K. Durrani, M. Ahmad, M. A. Hussain and N. Hussain
- 167 **Corrosion and protection characteristics of phosphate coatings: effect of yttrium oxide as additive**
By S.-L. Zhang, X.-L. Zhang, H.-H. Chen and M.-M. Zhang
- 172 **Electroplating of nickel from acetate based bath – Hull Cell studies**
By K. R. Marikkannu, K. Surya Kala, G. Paruthimal Kalaiganan and T. Vasudevan
- 179 **The use of ionic liquids in metal finishing and printed circuit manufacture**
By C. Larson and J. P. G. Farr
- 181 **Aerospace and Maritime Finishing**
By C. Arnold

- 183 **Ionic liquids in plating industry: opportunities and challenges**
By U. König and B. Sessler
- 189 **Technology road map for surface finishing industry**
By I. Dalrymple, D. Thery, P. Negré and U. König
- 193 **European funding: research opportunities for your organisation**
By A. Walker
- 196 **Review Electrofinishing of metals using eutectic based ionic liquids**
By A. O. Abbott, K. S. Ryder and U. König
- 205 **Electrodeposition of nanscaled palladium from hydrophobic ionic liquid**
By Y. Katayama, Y. Bando and T. Miura
- 211 **Electrodeposition of zinc-manganese alloy coatings from ionic liquid electrolytes**
By P. P. Chung, P. A. Cantwell, G. D. Wilcox and G. W. Critchlow
- 220 **Electrodeposition of tantalum and aluminium in ionic liquid [Py_{1,4}] TFSA**
By S. Zein El Abedin
- 227 **Electrodeposition of Al coating on Mg alloy from Al chloride/1-ethyl-3-methylimidazolium chloride ionic liquids with different Lewis acidity**
By J.-K. Chang, I.-W. Sun, S.-J. Pan, M.-H. Chuang, M.-J. Deng and W.-T. Tsai
- 234 **Electrodeposition of nickel using eutectic based ionic liquids**
By A. P. Abbott, K. El Ttaib, K. S. Ryder and E. L. Smith
- 242 **President's Address: picking up the gauntlet**
By J. P. G. Farr
- 248 **Arthur W. Hothersall: pioneering researcher**
By D. R. Gabe
- 249 **Pulse plating gaining importance – Review of the 3rd European Pulse Plating Seminar**
By W. Hansal
- 251 **Molybdate based conversion coatings for zinc and zinc alloy surfaces – Review**
By D. E. Walker and G. D. Wilcox
- 260 **Optimisation of electrochemical process parameters for giant magnetoresistance of electrodeposited Ni-Co(Cu)/Cu multilayers**
By S. M. S. I. Dulal and E. A. Charles
- 267 **Electrochemical fabrication of nano- and micrometric Cu particles: *in-situ* investigation by electroreflectance and optical second harmonic generation**
By B. Bozzini, L. D'Urzo and C. Mele
- 275 **Future of pulse plating silver**
By J. P. G. Farr
- 280 **Nitinol surface finishing by magnetoelectropolishing**
By R. Rokicki and T. Hryniewicz
- 286 **Effective conductivity measurements of silver coatings employing sapphire dielectric resonator technique**
By Z. Buczko and J. Krupka
- 289 **Eurocorr 2008**
By J. P. G. Farr
- 292 **REACH – its implications for platers and coaters**
By J. Oliver
- 293 **Latest Plating Technology for the PCB industry**
By P. Starkey
- 301 **Tribological behaviour of electrodeposited cobalt-tungsten coatings: dependence on current parameters**
By N. Tsyntsar, S. Belevsky, A. Dikumar and J.-P. Celis
- 308 **Influence of SiC+ WC addition to Cr(VI) bath on corrosion behaviour of coatings in sulphate solution**
By S. Survilienė, A. Češūnienė, V. Jasulaitienė and D. Bučinskienė
- 315 **Normal and anomalous electrodeposition of tin-copper alloys from methanesulphonic acid bath containing perfluorinated cationic surfactant**
By C. T. J. Low and F. C. Walsh
- 326 **Study of Bi₂S₃ interaction with Ni(II) ions**
By G. Valiuliene, A. Žielienė, V. Jasulaitienė, L. Naruškevičius and V. Pakštas
- 332 **Dependence of cavitation intensity on ultrasound frequency in ultrasonic cleaning processes in alkaline solutions**
By B. Niemczewski
- 337 **Basic analysis of transient curve on electroplating phenomena**
By P. Berçot